

Maximum Ratings:

Sub-Component Device: Pre-Biased PNP Transistor (Q1) @TA = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit		
Collector-Base Voltage	V _{CBO}	-50	V		
Collector-Emitter Voltage	V _{CEO}	-50	V		
Supply Voltage	Vcc	-50	V		
Input Voltage	V _{in}	+5 to -6	V		
Output Current	Ι _C	-200	mA		

Sub-Component Device: N-MOSFET With Gate Pull-Down Resistor (Q2)

@T_A = 25°C unless otherwise specified

Cha	racteristic	Symbol	Value	Unit
Drain-Source Voltage		V _{DSS}	60	V
Drain Gate Voltage (R _{GS} ≤1M C	Dhm)	V _{DGR}	60	V
Gate-Source Voltage	Continuous		+/-20	V
	Pulsed (tp<50 uS)	V _{GSS}	+/-40	v
Drain Current (Page 1: Note 3)	nt (Page 1: Note 3) Continuous (V _{gs} = 10V)		115	
	Pulsed (tp <10 uS, Duty Cycle <1%)	ID	800	mA
Continuous Source Current		ls	115	mA



Electrical Characteristics: Pre-Biased PNP Transistor (Q1) @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS					•	·
Collector-Base Cut Off Current	I _{CBO}	_	_	-100	nA	V _{CB} = -50V, I _E = 0
Collector-Emitter Cut Off Current	ICEO	_	_	-500	nA	V _{CE} = -50V, I _B = 0
Emitter-Base Cut Off Current	I _{EBO}	_	-0.5	-1	mA	V _{EB} = -5V, I _C = 0
Collector-Base Breakdown Voltage	V _{(BR)CBO}	-50	_	_	V	I _C = -10 uA, I _E = 0
Collector-Emitter Breakdown Voltage	V _{(BR)CEO}	-50			V	I _C = -2 mA, I _B = 0
Input Off Voltage	V _{I(OFF)}	_	-0.55	-0.3	V	V _{CE} = -5V, I _C = -100uA
Output Voltage	V _{OH}	-4.9	_	_	V	V_{CC} = -5V, V_B = -0.05V, R _L = 1K
Ouput Current (leakage current same as I _{CEO})	I _{O(OFF)}	_	_	-500	nA	$V_{CC} = -50V, V_1 = 0V$
ON CHARACTERISTICS						
		—	—	-0.15	V	I _C = -10 mA, I _B = -0.5 mA
			_	-0.2	V	I _C = -50mA, I _B = -5mA
Collector-Emitter Saturation Voltage	Variation		_	-0.2	V	$I_{\rm C}$ = -20mA, $I_{\rm B}$ = -1mA
	V _{CE(SAT)}			-0.25	V	I _C = -100mA, I _B = -10mA
			~~	-0.25	v	I _C = -200mA, I _B = -10mA
				-0.3	V	I_{C} = -200mA, I_{B} = -20mA
Equivalent On-Resistance*	R _{CE(SAT)}	_	_	1.5	Ω	I _C = -200mA, I _B = -10mA
		60	150		_	V_{CE} = -5V, I_{C} = -20 mA
DC Current Gain	h	60	215			V_{CE} = -5V, I_{C} = -50 mA
	h _{FE}	60	245		_	V _{CE} = -5V, I _C = -100 mA
		60	250	_	_	V_{CE} = -5V, I_{C} = -200 mA
Input On Voltage	V _{I(ON)}	-2.45	-0.7	_	V	V_{O} = -0.3V, I_{C} = -2 mA
Output Voltage (equivalent to $V_{CE(SAT)} \text{ or } V_{O(ON)}$)	V _{OL}	—	-0.065	-0.15	V	V _{CC} = -5V, v _B = -2.5V, I _o /I _I = -50mA /-2.5mA
Input Current	li	_	-9	-28	mA	V _I = -5V
Base-Emitter Turn-on Voltage	V _{BE(ON)}		-1.13	-1.3	V	V _{CE} = -5V, I _C = 200mA
Base-Emitter Saturation Voltage	N		-3.2	-3.6	v	I _C = -50mA, I _B = -5mA
Base-Emilier Saturation Voltage	V _{BE(SAT)}		-4.6	-5.5	V	I _C = -80mA, I _B = -8mA
Input Resistor (Base), +/- 30%	R2		0.47	_	KΩ	—
Pull-up Resistor (Base to Vcc supply), +/- 30%	R1	—	10	_	KΩ	—
Resistor Ratio (Input Resistor/Pull-up resistor) +/- 20%	R1/R2	—	21	—	—	—
SMALL SIGNAL CHARACTERISTICS						
Transition Frequency (Gain Bandwidth Product)	f⊤	—	200	—	MHz	V _{CE} = -10V, I _E = -5mA, f = 100MHz
Collector Capacitance, (C _{cbo} -Output Capacitance)	C _C	_	20		pF	V _{CB} = -10V, I _E = 0A, f = 1MHz

* Pulse Test: Pulse width, tp<300 $\mu\text{S},$ Duty Cycle, d<=0.02



Electrical Characteristics: N-MOSFET with Gate Pull-Down Resistor (Q2)

@T_A = 25°C unless otherwise specified Characteristic Symbol Unit **Test Condition** Min Тур Max **OFF CHARACTERISTICS (Note 4)** V $V_{GS} = 0V, I_D = 10 \mu A$ Drain-Source Breakdown Voltage, BV_{DSS} V_{(BR)DSS} 60 Zero Gate Voltage Drain Current (Drain Leakage 1 V_{GS} =0V, V_{DS} = 60V IDSS μA ____ ____ Current) Gate-Body Leakage Current, Forward 0.95 mΑ V_{GS} = 20V, V_{DS} = 0V IGSSF Gate-Body Leakage Current, Reverse $V_{GS} = -20V, V_{DS} = 0V$ IGSSR -0.95 mΑ ON CHARACTERISTICS (Note 4) Gate Source Threshold Voltage (Control Supply V 1 22 $V_{DS} = V_{GS}, I_D = 0.25 mA$ 1.9 V_{GS(th)} Voltage) ____ 0.10 1.5 $V_{GS} = 5V, I_D = 50mA$ Static Drain-Source On-State Voltage V V_{DS(on)} V_{GS} = 10V, I_D = 115mA 0.15 3.75 $V_{GS} = 10V$ On-State Drain Current 500 ____ mΑ I_{D(on)} $V_{DS} \ge 2_X V_{DS(ON)}$ 3 1.6 V_{GS} = 5V, ID = 50mA Static Drain-Source On-Resistance Ω R_{DS(on)} 2 V_{GS} = 10V, ID = 500mA 1.4 240 80 V_{DS} ≥2_XV_{DS(ON)}, I_D = 115 mA Forward Transconductance mS **g**fs 80 350 $V_{DS} \ge 2_X V_{DS(ON)}$, $I_D = 200 \text{ mA}$ Gate Pull-Down Resistor, +/- 30% R3 37 KΩ DYNAMIC CHARACTERISTICS Input Capacitance Ciss 50 pF $V_{DS} = -25V, V_{GS} = 0V,$ Output Capacitance 25 pF Coss f = 1MHz pF Reverse Transfer Capacitance Crss 5 SWITCHING CHARACTERISTICS Turn-On Delay Time 20 V_{DD} = 30V, V_{GS} =10V, ns t_{D(on)} ____ $I_{D} = 200 mA$, Turn-Off Delay Time 40 ns t_{D(off)} R_G = 25 Ohm, R_L = 150 Ohm SOURCE-DRAIN (BODY) DIODE CHARACTERISTICS AND MAXIMUM RATINGS Drain-Source Diode Forward On-Voltage V 1.5 $V_{GS} = 0V, I_{S} = 115 \text{ mA}$ V_{SD} 0.90 Maximum Continuous Drain-Source Diode Forward ls 115 mΑ Current (Reverse Drain Current) ____ ____

ISM

800

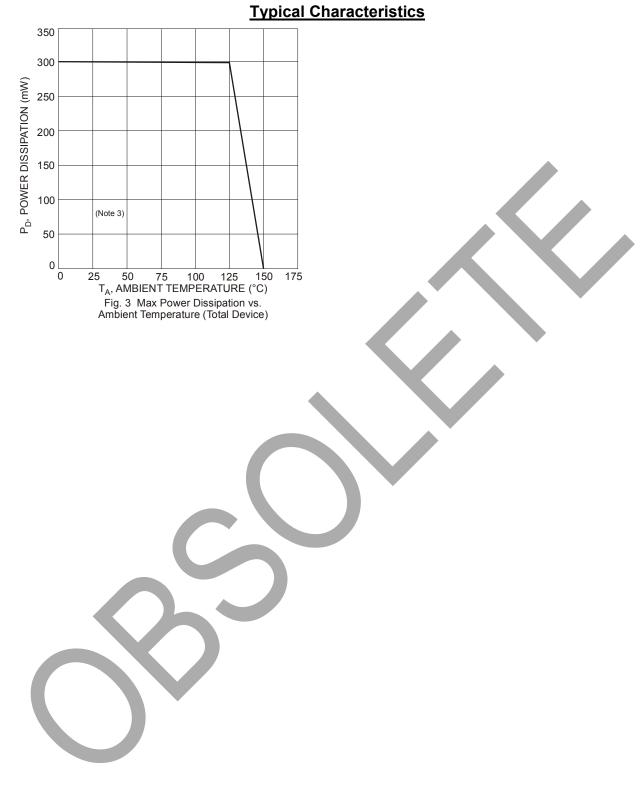
mΑ

Notes: 4. Short duration pulse test used to minimize self-heating effect.

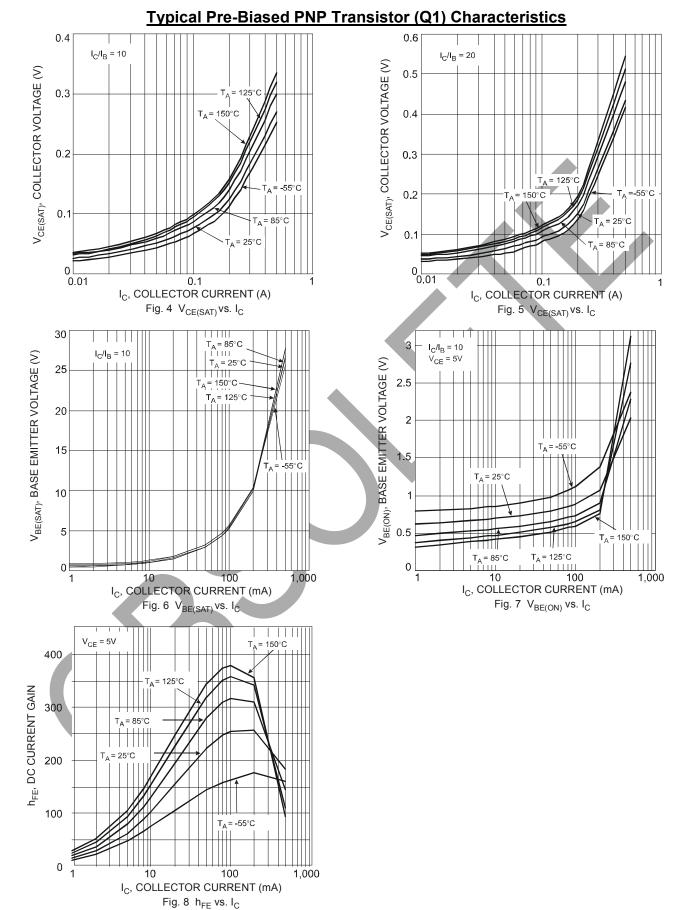
Maximum Pulsed Drain-Source Diode Forward

Current







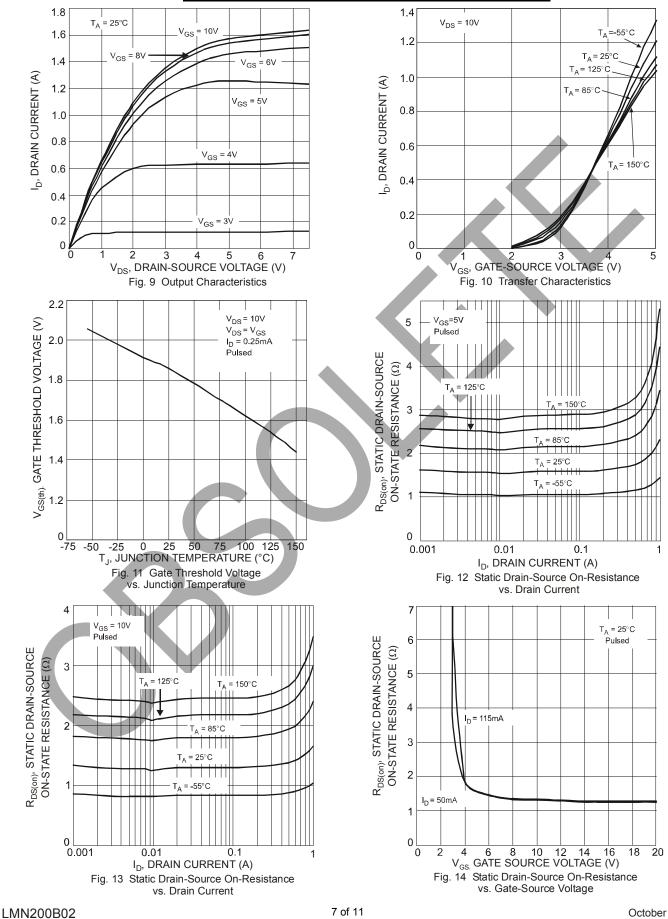


OBSOLETE – PART DISCONTINUED

LMN200B02 Document number: DS30658 Rev. 8 - 4 Downloaded from Arrow.com.



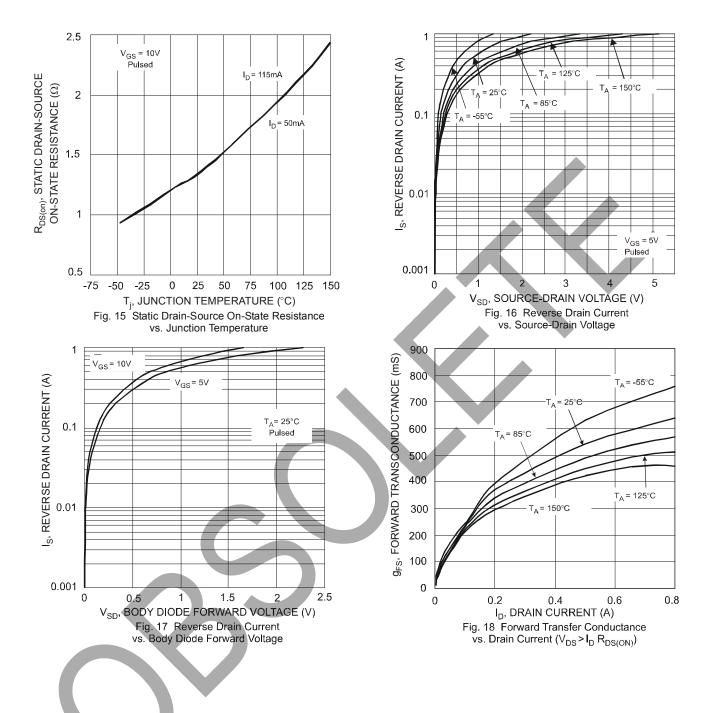
Typical N-Channel MOSFET (Q2) Characteristics



OBSOLETE - PART DISCONTINUED

Document number: DS30658 Rev. 8 - 4 Downloaded from Arrow.com.

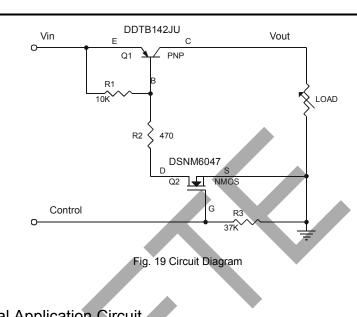




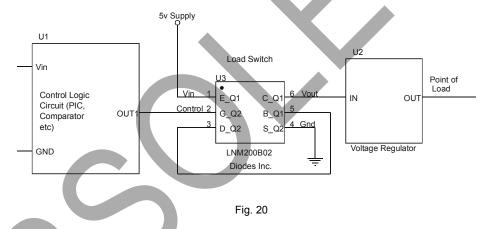


Application Details

PNP Transistor (DDTB142JU) and N-MOSFET (DSNM6047) with gate pull-down resistor integrated as one in LMN200B02 can be used as a discrete entity for general purpose applications or as an integrated circuit to function as a Load Switch. When it is used as the latter as shown in Fig 19, various input voltage sources can be used as long as it does not exceed the maximum ratings of the device. These devices are designed to deliver continuous output load current up to a maximum of 200 mA. The MOSFET Switch draws no current, hence loading of control circuit is prevented. Care must be taken for higher levels of dissipation while designing for higher load conditions. These devices provide high power and also consume less space. The product mainly helps in optimizing power usage, thereby conserving battery life in a controlled load system like portable battery powered applications. (Please see Fig. 20 for one example of a typical application circuit used in conjunction with voltage regulator as a part of a power management system)



Typical Application Circuit

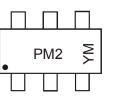


Ordering Information (Note 5)

Device	Packaging	Shipping							
LMN200B02-7	SOT-363	3000/Tape & Reel							
Notes: 5. For packaging details, go to our website at http://ww	w.diodes.com/datasheets/ap02007.pdf.								

5. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



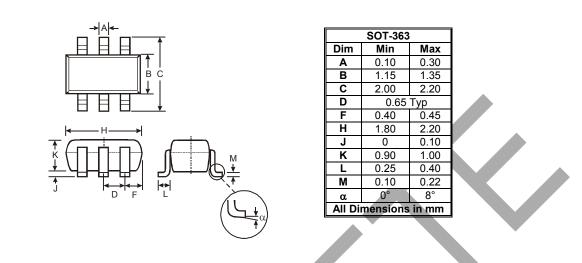
PM2 = Product Type Marking Code, YM = Date Code Marking Y = Year (ex: T = 2006)M = Month (ex: 9 = September)

Date	Code	Kev

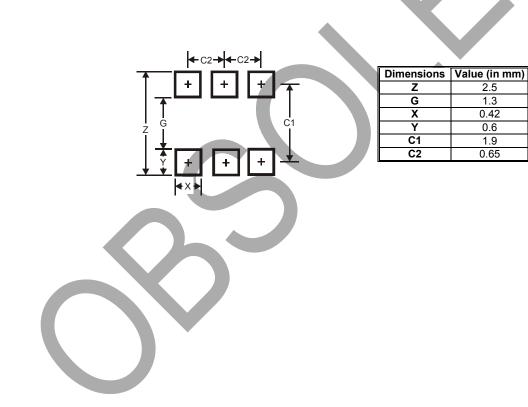
Date Code Re	<i>.</i> y											
Year	2006	2007	20	08	2009	2010	2011	2012	20	13	2014	2015
Code	Т	U	١	/	W	Х	Y	Z	/	4	В	С
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	Ν	D



Mechanical Details



Suggested Pad Layout





IMPORTANT NOTICE

1. DIODES INCORPORATED AND ITS SUBSIDIARIES ("DIODES") MAKE NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO ANY INFORMATION CONTAINED IN THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

2. The Information contained herein is for informational purpose only and is provided only to illustrate the operation of Diodes products described herein and application examples. Diodes does not assume any liability arising out of the application or use of this document or any product described herein. This document is intended for skilled and technically trained engineering customers and users who design with Diodes products. Diodes products may be used to facilitate safety-related applications; however, in all instances customers and users are responsible for (a) selecting the appropriate Diodes products for their applications, (b) evaluating the suitability of the Diodes products for their intended applications, (c) ensuring their applications, which incorporate Diodes products, comply the applicable legal and regulatory requirements as well as safety and functional-safety related standards, and (d) ensuring they design with appropriate safeguards (including testing, validation, quality control techniques, redundancy, malfunction prevention, and appropriate treatment for aging degradation) to minimize the risks associated with their applications.

3. Diodes assumes no liability for any application-related information, support, assistance or feedback that may be provided by Diodes from time to time. Any customer or user of this document or products described herein will assume all risks and liabilities associated with such use, and will hold Diodes and all companies whose products are represented herein or on Diodes' websites, harmless against all damages and liabilities.

4. Products described herein may be covered by one or more United States, international or foreign patents and pending patent applications. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks and trademark applications. Diodes does not convey any license under any of its intellectual property rights or the rights of any third parties (including third parties whose products and services may be described in this document or on Diodes' website) under this document.

5. provided subject to Diodes' Standard Terms and Conditions of Sale Diodes products are (https://www.diodes.com/about/company/terms-and-conditions/terms-and-conditions-of-sales/) or other applicable terms. This document does not alter or expand the applicable warranties provided by Diodes. Diodes does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel.

6. Diodes products and technology may not be used for or incorporated into any products or systems whose manufacture, use or sale is prohibited under any applicable laws and regulations. Should customers or users use Diodes products in contravention of any applicable laws or regulations, or for any unintended or unauthorized application, customers and users will (a) be solely responsible for any damages, losses or penalties arising in connection therewith or as a result thereof, and (b) indemnify and hold Diodes and its representatives and agents harmless against any and all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim relating to any noncompliance with the applicable laws and regulations, as well as any unintended or unauthorized application.

7. While efforts have been made to ensure the information contained in this document is accurate, complete and current, it may contain technical inaccuracies, omissions and typographical errors. Diodes does not warrant that information contained in this document is error-free and Diodes is under no obligation to update or otherwise correct this information. Notwithstanding the foregoing, Diodes reserves the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. This document is written in English but may be translated into multiple languages for reference. Only the English version of this document is the final and determinative format released by Diodes.

8. Any unauthorized copying, modification, distribution, transmission, display or other use of this document (or any portion hereof) is prohibited. Diodes assumes no responsibility for any losses incurred by the customers or users or any third parties arising from any such unauthorized use.

Copyright © 2021 Diodes Incorporated

www.diodes.com